

in a liquid or a liquid precursor of the optical material being substantially different from that of peripheries of the features, there not being a starting material for forming the features at the predetermined positions.

2. (Three Times Amended) A method of manufacturing a display device, the method comprising the steps of:

forming features of which repellency to an optical material in a liquid or a liquid precursor of the optical material is substantially different from that of peripheries of the features on an object comprising a display substrate so that a difference in height between the features and predetermined positions defined by the features is formed; and

applying the optical material or the liquid precursor to the surface where the features are formed by an ink jet method.

3. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features being recesses that are less repellent to the optical material in liquid or the liquid precursor, compared to the peripheries of the recesses; and

the optical material being disposed at the predetermined positions, by a process including application of the optical material or the liquid precursor to the surface having recesses, with the surface facing upward.

4. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features being formed in such a manner being projections that are less repellent to the optical material in liquid or the liquid precursor, compared to the peripheries of the projections; and

the optical material being disposed at the predetermined positions, by a process including application of the optical material or the liquid precursor to the surface having projections, with the surface facing downward.

5. (Three Times Amended) A method of manufacturing a display, the method comprising the steps of:

forming a plurality of first bus lines;

forming a plurality of second bus lines;

forming features of which repellency to an optical material in a liquid or a liquid precursor of the optical material is different from that of the peripheries of the features so that the features define predetermined positions and a difference in height between the features and the predetermined positions defined by the features is formed;

applying the optical material or the liquid precursor to the surface where the features are formed.

6. (Three Times Amended) The method of manufacturing a display device according to claim 5, the method further comprising the steps of:

forming a layer to be transferred, including a plurality of second bus lines, on a peeling layer; and

transferring the layer to be transferred onto the surface coated by the optical material or the precursor.

7. (Three Times Amended) A method of manufacturing a display device, the method comprising the steps of:

forming wiring including a plurality of scanning lines and signal lines;

forming features of which repellency to an optical material liquid or a liquid precursor of the optical material is different from that of peripheries of the features so that the features define predetermined positions at a surface of an object including a display substrate; and

applying the optical material liquid or the liquid precursor to the surface of the object having features.

8. (Three Times Amended) A method of manufacturing a display device, the method comprising the steps of:

disposing an optical material or a precursor of the optical material at predetermined positions defined by features formed on an object including a display substrate;

forming a layer to be transferred, including a plurality of scanning lines and signal lines, pixel electrodes and switching elements, for controlling the pixel electrodes, on a peeling layer formed on a peeling substrate; and

transferring the layer to be transferred onto the object coated by the optical material or the precursor .

9. (Three Times Amended) The method of manufacturing a display device according to Claim 5, the features comprising at least one of the bus lines.

10. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features comprising wiring including a plurality of scanning lines or signal lines.

11. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features comprising pixel electrodes.

12. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features comprising an interlayer insulation film.

13. (Three Times Amended) The method of manufacturing a display device according to Claim 2, the features comprising a light shielding layer.

14. (Three Times Amended) The method of manufacturing a display device according to claim 2, in the step of forming features, the features being formed by application of a material in liquid followed by removal of the material.

50. (Amended) A display device comprising:  
switching elements;  
an optical material arranged at predetermined positions on an object comprising a display substrate, scanning lines and signal lines;  
the predetermined positions being defined by features of which repellency to a solution of the optical material or a precursor of the optical material is substantially different from that of peripheries of the features, there not being a starting material for forming the features of the predetermined positions.

51. (Amended) The display device according to claim 50, the predetermined positions being lower in height one between the features and the peripheries.

Please add new claims 53-65 as follows:

--53. The method of manufacturing a display device according to claim 2, the method further comprising forming scanning lines and signal lines.--

--54. The method of manufacturing a display device according to claim 53, the method further comprising forming switching elements.--

--55. The method of manufacturing a display device according to claim 54, the switching elements being thin film transistors.--

--56. The display device according to claim 1, the switching elements being thin film transistors.--

--57. The display device according to claim 1, further comprising scanning lines and signal lines.--

--58. The display device according to claim 57, the features being projections which surround the optical material.--

--59. The display device according to claim 58, the scanning lines and signal lines being formed below the projections--

--60. A display device comprising:  
an optical material arranged at predetermined positions on an object comprising a display substrate, first bus lines, and second bus lines, the predetermined positions being defined by features of which repellency to the optical material in liquid or a liquid precursor of the optical material is substantially different from that of the peripheries of the features; and

the optical material being arranged by ink jet method,  
there not being a starting material for forming the features at the predetermined positions.--

--61. A display device comprising:  
an optical material arranged at predetermined positions defined by features on an object comprising a display substrate, scanning lines, and signal lines,  
there not being a starting material for forming the features at the predetermined positions.--

--62. The method device comprising according to claim 61, further comprising switching elements.--

--63. The display device according to claim 62, the switching elements being thin film transistors.--

--64. The display device according to claim 50, the features being projections which surround the optical material.--